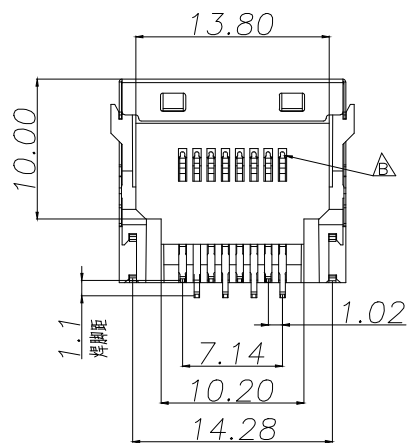
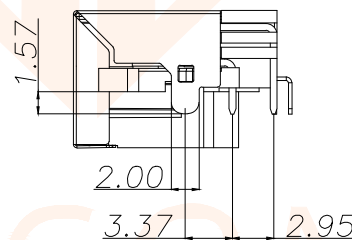
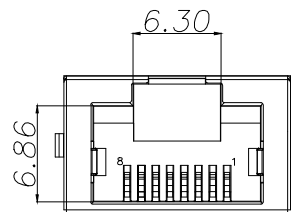
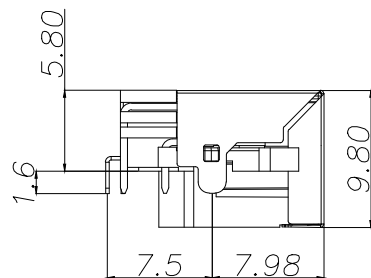
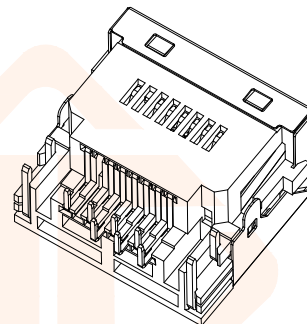
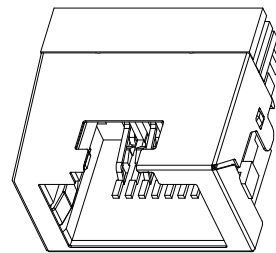
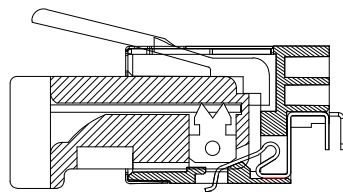
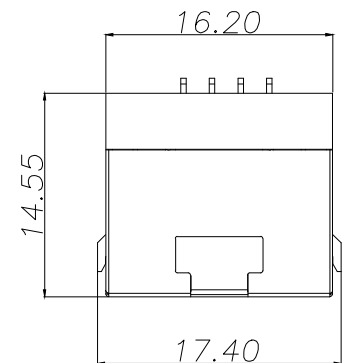


8	—
7	—
6	RX-
5	—
4	—
3	RX+
2	TX-
1	TX+
PIN	说明

LED electrical characteristic			
Node			
A1(+)	A2(-)	A1	A2
B1(+)	B2(-)	B1	B2

REV.	ECN NO.	DESCRIPTION	DATE	DESIGN

NOTES

MATERIAL

- 1.HOUSING MATERIAL:THERMO PLASTICS UL94V-0 .
- 2.CONTACT MATERIAL :PHOSPHOR BRONZE T=0.25mm.
SELECT GOLD PLATING ON CONTACT AREA AND TIN PLATING ON SOLDER AREA OVER NICKEL.
- 3.SHIELD: STAINLESS T=0.20mm NI PLATING.
- 4.GASKET :SPCC T=0.40 NI PLATING.
- 5.LED:TIN PLATING.

MELECTRICAL

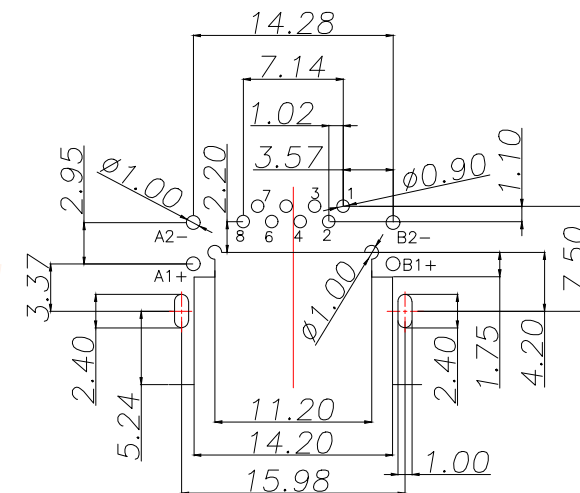
- 1.VOLTAGE RATING: 125 VAC RMS.
- 2.CURRENT RATING: 1.5 AMP.
- 3.CONTACT RESISTANCE: 40 MILLIOHMS MAX.
- 4.INSULATION RESISTANCE: 500 MEGOHMS MIN @ 100V DC
- 5.DIELECTRIC DIELECTRIC
RESISTANCE: 500V DC RMS 50Hz. 1MIN.

MECHANICAL

- 1.DURRABILITY: 750 CYCLES MIN.
- 2.MATING/UNMATING FORCE: 2.24 KG.F MAX.

ENVIRONMENTAL:

- 1.STORAGE: -40℃~+85℃.
- 2.OPERATION: -40℃~+85℃.



PCBLAYOUT T=1.2

TOL:±0.05

TOLERANCE		深圳聚兴泰电子科技有限公司 Shenzhen Juxingtai Electronic Technology Co., Ltd	
X.:±0.35	X':±3"	PART NO.	TITLE:
X.X:±0.25	X.X':±2"	RJ45-5201-8P	RJ45 沉板4.0 DIP 带壳 无灯
X.XX:±0.15	X.XX':±1"	DESIGN: Ethan	MANUFACTURE DWG
UNITS	mm	CHED: Olvia	
MATERILA	— — —	APPD: Ava	
FINISH	— — —		SCALE SHEET N:A 1/1